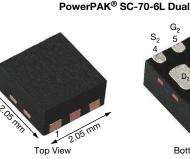
SiA931DJ

www.vishay.com

Dual P-Channel 30 V (D-S) MOSFET





Marking code: DO

PRODUCT SUMMARY						
V _{DS} (V)	-30					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.065					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -6 V	0.080					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.100					
Q _g typ. (nC)	4.1					
I _D (A) ^a	-4.5					
Configuration	Dual					

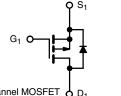
FEATURES

- TrenchFET[®] Gen III power MOSFET
- Thermally enhanced PowerPAK[®] SC-70 package
- Small footprint area - Low on-resistance
- 100 % R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

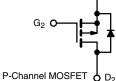
- Smart phones, tablet PCs, mobile computing: Battery switches

 - Load switches
 - Power management
 - DC/DC converters





P-Channel MOSFET



ORDERING INFORMATION

Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA931DJ-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	-30	V		
Gate-source voltage		V _{GS}	V _{GS} ± 20			
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		-4.5 ^a			
	T _C = 70 °C	I _D	-4.5 ^a			
	T _A = 25 °C		-4.3 ^{b, c}			
	T _A = 70 °C		-3.4 ^{b, c}	А		
Pulsed drain current (t = 300 μs)			-28			
Continuous source-drain diode current	T _C = 25 °C	I _S	-4.5 ^a			
Continuous source-drain diode current	T _A = 25 °C		-1.6 ^{b, c}			
Maximum power dissipation	T _C = 25 °C	PD	7.8			
	T _C = 70 °C		5	w		
	T _A = 25 °C		1.9 ^{b, c}	vv		
	T _A = 70 °C		1.2 ^{b, c}			
Operating junction and storage temperature range	ge	T _J , T _{stg}	-55 to +150	°C		
Soldering recommendations (peak temperature) d, e			260			

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	12.5	16	0/10	

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

Maximum under steady state conditions is 110 °C/W f.

S13-1163-Rev. A, 13-May-13

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Document Number: 62859

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SiA931DJ

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	· .						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-24	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	3.4	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1.2	-	-2.2	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zere gete veltage dreip ourrent		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1		
Zero gate voltage drain current	IDSS	V_{DS} = -30 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	-10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-10	-	-	А	
Drain-source on-state resistance ^a		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -3 \text{ A}$	-	0.052	0.065		
	R _{DS(on)}	$V_{GS} = -6 \text{ V}, \text{ I}_{D} = -2 \text{ A}$	-	0.063	0.080	Ω	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$	-	0.077	0.100	1	
Forward transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -3 A	-	8	-	S	
Dynamic ^b			•	•			
Input capacitance	C _{iss}		-	445	-	pF	
Output capacitance	Coss	V _{DS} = -15 V, V _{GS} = 0 V, f = 1 MHz	-	55	-		
Reverse transfer capacitance	C _{rss}		-	45	-		
Tatal asta sharra		$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -4 \text{ A}$	-	8.5	13	nC	
Total gate charge	Qg		-	4.1	6.2		
Gate-source charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -4.5 V, I_{D} = -4 A	-	1.2	-		
Gate-drain charge	Q _{gd}		-	1.5	-		
Gate resistance	Rg	f = 1 MHz	1.1	5.5	11	Ω	
Turn-on delay time	t _{d(on)}		-	23	45		
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 5 \Omega$	-	18	35	1	
Turn-off delay time	t _{d(off)}	$I_D \cong -3$ Å, $V_{GEN} = -4.5$ V, $R_g = 1 \Omega$	-	17	35		
Fall time	t _f		-	5	10		
Turn-on delay time	t _{d(on)}		-	8	15	ns	
Rise time	tr	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 5 \Omega$	-	5	10	-	
Turn-off delay time	t _{d(off)}	$I_D \cong -3$ Å, $V_{GEN} = -10$ V, $R_g = 1$ Ω	-	20	40		
Fall time	t _f		-	5	10		
Drain-Source Body Diode Characterist	ics		•	•			
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-4.5		
Pulse diode forward current	I _{SM}		-	-	-15	A	
Body diode voltage	V _{SD}	I _S = -3 A, V _{GS} = 0 V	-	-0.9	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	15	30	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -3 A, di/dt = 100 A/μs,	-	8	20	nC	
Reverse recovery fall time	ta	$T_J = 25 \text{ °C}$	-	10	-		
Reverse recovery rise time	t _b		-	5	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

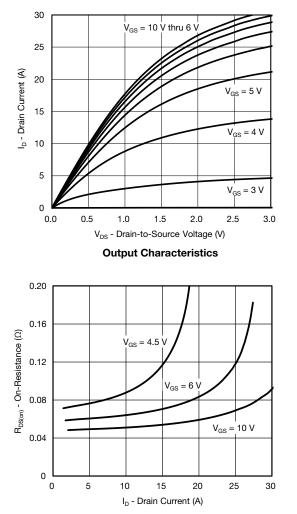
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

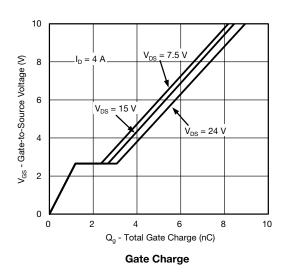
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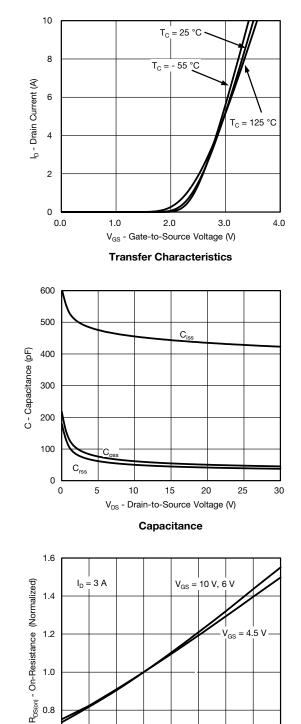


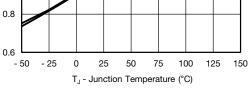
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Drain Current and Gate Voltage





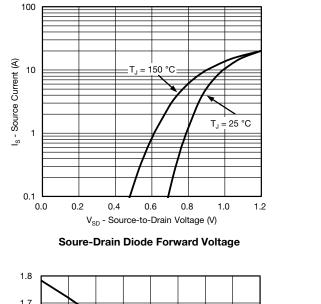


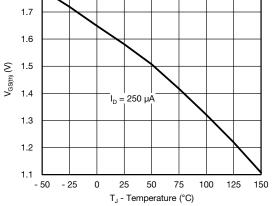
On-Resistance vs. Junction Temperature

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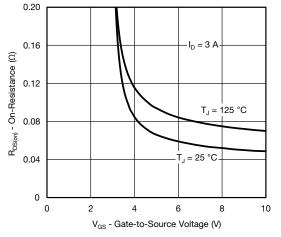


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

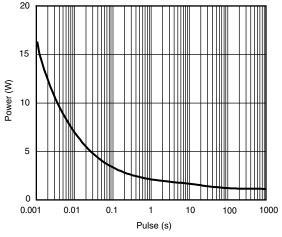




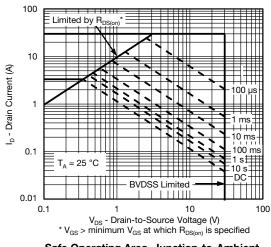




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

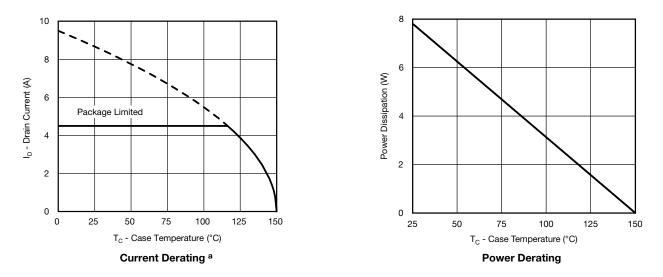
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SiA931DJ

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

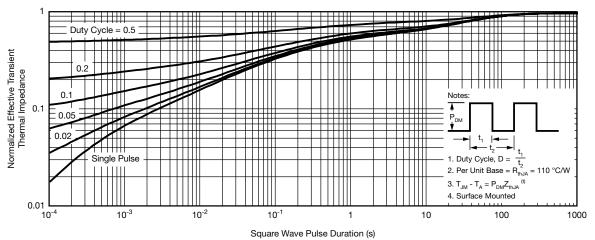


Note

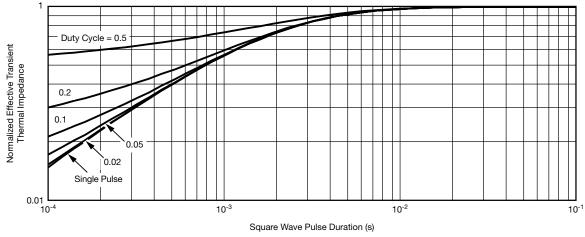
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



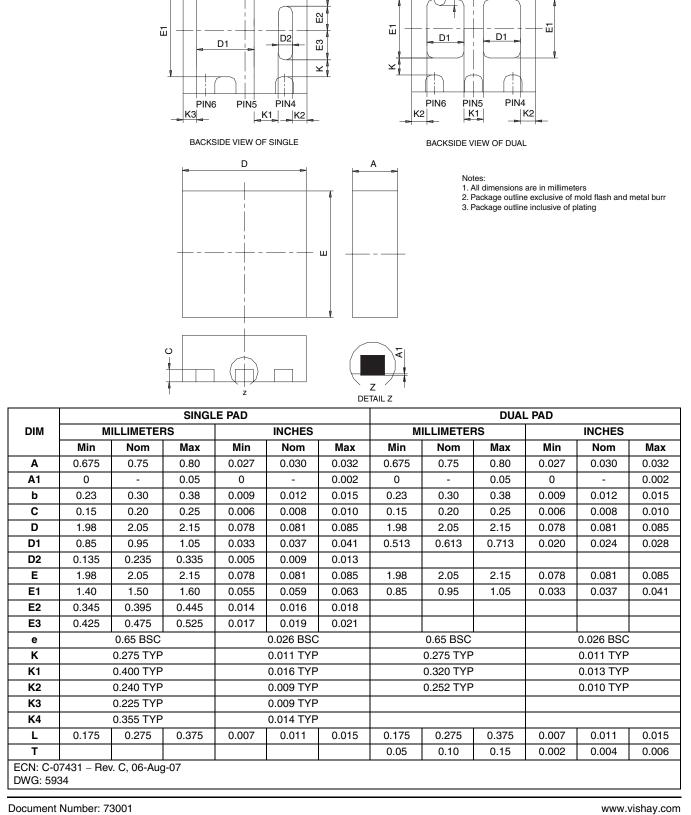
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

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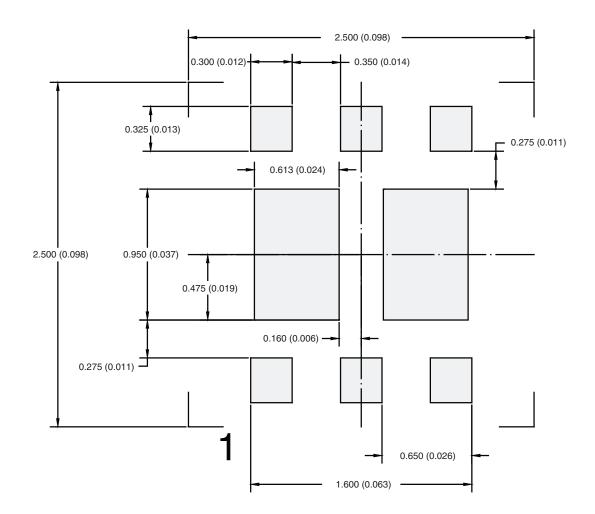
¹

Application Note 826

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RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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